

PATENT APPLICATION Attorney's Do. No. 9903-28

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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ADRIENNE CHOCHOLAK (SENDER'S PRINTED NAME)

Box Patent Application

U. S. Patent and Trademark Office

P. O. Box 2327

Arlington, VA 22202

Enclosed for filing is a patent application under 37 CFR 1.53(b) of:

Inventor

Tae-Sub CHANG, Dong-Ho LEE and Min-Young SON:

For:

WAFER LEVEL PACKAGE INCLUDING GROUND METAL LAYER

Applicant requests FIG. 4A to be published with the application.

Enclosures:

Specification (pages 1-7); claims (pages 8-10); abstract (page 11)

SIX sheet(s) of FORMAL drawings

Declaration or Combined Declaration and Power of Attorney

Newly executed (original or copy)

Assignment with cover sheet \boxtimes

Assignee Name and Address:

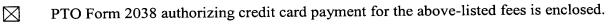
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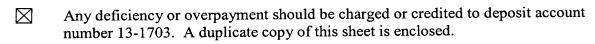
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	<u>CLAIM</u> :	S AS FILED			
For	Number Filed	Number Extra	Rate		Basic Fee \$740
Total Claims	20-20	0	x \$ 18	=	0
Independent Claims	2-3	0	x \$ 84	=	0
TOTAL FILING FEE					\$740









Respectfully submitted,

MARGER JOHNSON & McCOLLOM, P.C.

Alan T. McCollom Reg. No. 28,881

MARGER JOHNSON & McCOLLOM, P.C. 1030 SW Morrison Street Portland, OR 97205 503-222-3613

PATENT	APPLICATION	SERIAL	NO.	

U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE FEE RECORD SHEET

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